



## RF/Microwave Device and Circuit Integration Technology

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### Message from the Guest Editors

Dear Colleagues,

This Special Issue is aimed at addressing the issues involved in the analysis, design, and implementation of the novel RF/MW components, antenna, and systems for different wireless applications. This includes, but not limited to, the following:

- Passive and active components;
- Various integration technologies for RF/Microwave device design;
- High-frequency integrated circuit analysis and design;
- Integrated antenna and arrays;
- Integrated radar;
- Remote sensing systems based on RF/MW techniques.

Deadline for manuscript  
submissions:

**31 December 2024**





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## Editor-in-Chief

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## Message from the Editor-in-Chief

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